

Peak performance for your print embellishment:

- Single Path
- Patented Ink-on-Foil technology for metallization
- Wide variety of substrates
- High speed/performance
- High application accuracy
- Industrial, process-reliable machine platform

Sheet fed solutions:

DM-MAXLINER B3 T

Format: B3

Technical data: 

Tactile experience:
Flat

Application:
Metallization

Speed:
Up to 3,000 s/h



KURZ Foil-on-Toner Technology

DM-MAXLINER B3

Format: B3

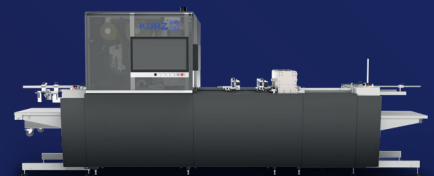
Technical data: 

Tactile experience:
Flat, haptic

Application:
Metallization, varnish

Option:
VDP

Speed:
Up to 3,500 s/h



Patented KURZ Ink-on-Foil Technology (IoF)

DM-MAXLINER B2

Format: B2 and B2 long

Technical data: 

Tactile experience:
Flat, haptic, relief

Application:
Metallization, varnish

Option:
VDP, long version

Speed:
Up to 2,500 s/h



Patented KURZ Ink-on-Foil Technology (IoF)

DM-MAXLINER B2 V

Format: B2 short or long

Technical data: 

Tactile experience:
Flat, haptic, relief,
micro embossing

Application:
Metallization, varnish

Option:
VDP

Speed:
Up to 2,500 s/h



Patented KURZ Ink-on-Foil (IoF) plus KURZ Ink-on-Substrate Technology (IoS)

DM-MAXLINER B1

Format: B1

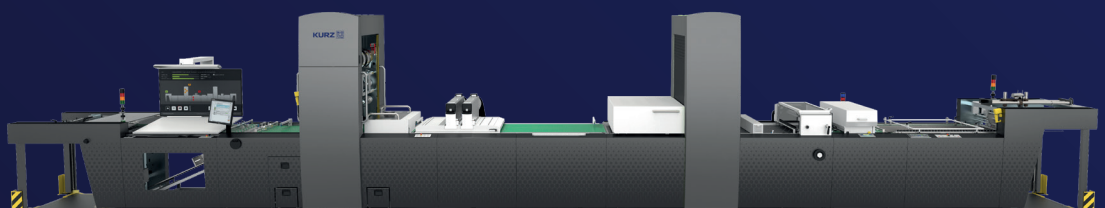
Technical data: 

Tactile experience:
Flat, haptic, relief,
micro embossing

Application:
Metallization, varnish

Option:
VDP

Speed:
Up to 10,000 s/h



KURZ Ink-on-Substrate Technology (IoS)

Web fed solutions:

DM-JETLINER

Web width: 330 mm

Technical data: 

Tactile experience:
Flat

Application:
Metallization in-line
with HP 6K Series

Option:
Substrate buffer,
Inspection table

Speed:
Up to 75 m/min



Patented KURZ Ink-on-Foil Technology (IoF)

DM-FLEXLINER

Web width: 330 mm, 440 mm

Technical data: 

Tactile experience:
Flat, haptic

Application:
Varnish

Option:
Metallization in combination
with separate foil winders

Speed:
Up to 140 m/min



KURZ Ink-on-Substrate Technology (IoS)

DM-UNILINER

Web width: 330 mm

Technical data: 

Tactile experience:
Flat, haptic

Application:
Metallization, varnish

Option:
Lamination unit, flexo,
die cutting

Speed:
Up to 100 m/min



KURZ Ink-on-Substrate Technology (IoS)

